## 505686295 09/23/2019

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
TAO LUO	01/05/2015
SHIMMAN ARVIND PATEL	01/05/2015
WANSHI CHEN	01/05/2015
NAGA BHUSHAN	01/05/2015
YONGBIN WEI	01/05/2015
HAO XU	01/05/2015
ALEKSANDAR DAMNJANOVIC	01/05/2015
TINGFANG JI	01/08/2015
DURGA PRASAD MALLADI	01/05/2015
SRINIVAS YERRAMALLI	01/05/2015
PETER GAAL	01/07/2015

## **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED	
Street Address:	5775 MOREHOUSE DRIVE	
City:	SAN DIEGO	
State/Country:	CALIFORNIA	
Postal Code:	92121-1714	

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16579453

# **CORRESPONDENCE DATA**

**Fax Number:** (303)473-2720

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 303-473-2700

**Email:** dlwilliams@hollandhart.com

Correspondent Name: HOLLAND & HART LLP/QUALCOMM

Address Line 1: P.O. BOX 11583

Address Line 4: SALT LAKE CITY, UTAH 84147

PATENT REEL: 050465 FRAME: 0082

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ATTORNEY DOCKET NUMBER:	PQ211.01.02 (81679.4601)	
NAME OF SUBMITTER:	J. SCOTT KARREN	
SIGNATURE:	/J. Scott Karren/	
DATE SIGNED:	09/23/2019	
Total Attachments: 4 source=143953_Assignment_Signed_01122015_10762319_1#page1.tif		

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## **ASSIGNMENT**

# WHEREAS, WE,

- 1. **Tao Luo**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 2. **Shimman Arvind Patel**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 3. **Wanshi Chen,** a citizen of the People's Republic of China, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 4. **Naga Bhushan**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 5. **Yongbin Wei,** a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 6. **Hao Xu,** a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 7. **Aleksandar Damnjanovic**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of Del Mar, California,
- 8. **Tingfang Ji**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 9. **Durga Prasad Malladi,** a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
- 10. **Srinivas Yerramalli**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,

11. **Peter Gaal,** a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to TECHNIQUES FOR CONFIGURING PREAMBLE AND OVERHEAD SIGNALS FOR TRANSMISSIONS IN AN UNLICENSED RADIO FREQUENCY SPECTRUM BAND (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/584,149 filed December 29, 2014, Qualcomm Reference No. 143953 and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/969,080, filed March 21, 2014, Qualcomm Reference No. 143953P1, and 61/992,174, filed May 12, 2014, Qualcomm Reference No. 143953P2, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or

may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at <u>Six Pig</u> , on	15/2015	
LOCATION	DATE	Tao Luo
Done at No. 7 (A), on	1/5/2015	<u> Min Itl</u>
LOCATION	DATÉ	Shimman Arvind Patel
Done at Sear July, on	1/5/2/5	
LOCATION	DATE	Wanshi Chen
Done at <u>SAM DIEGO</u> , on LOCATION	1-5-15	<u> </u>
LOCATION	DATE	Naga Bhushan
Done at Scan Dieg, on LOCATION	1651245	
LOCATION ()	DATE	Yongbin Wei
Done at Side Diego, on LOCATION	1/5/20/\$	
LOCATION	DATE	Hao Xu
Done at San Mers as on	115118	<u> </u>
LOCATION	DATE	Aleksandar Damnjanovic
Done at Sand Degra, A on	1/8/205	
LOCATION	DATE	Tingfang Ji
Done at San Diego, on	1515	
LOCATION	DATE	Durga Prasad Malladi
Done at Sam Diego, on	15/15	
LOCATION	DATE	Srinivas Yerramalli
Done at San Piess, on	01/07/215	and the same of th
LOCATION	PATE	Pater Caal

PATENT REEL: 050465 FRAME: 0087

**RECORDED: 09/23/2019**